LNJ216C82RA

Hight Bright Surface Mounting Chip LED

3216 Micro-Lens Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	55	mW	
Forward current	I _F	20	mA	
Pulse forward current *	I _{FP}	60	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

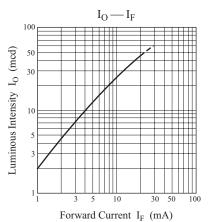
• Red

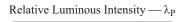
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

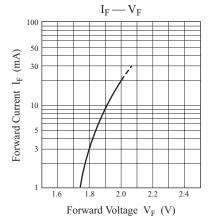
Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

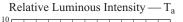
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_{\rm F} = 10 {\rm mA}$	12.8	24.0		mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_{\rm F} = 10 {\rm mA}$		1.92	2.5	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 10 \ {\rm mA}$		645		nm
Spectral half band width	Δλ	$I_{\rm F} = 10 \ {\rm mA}$		22		nm

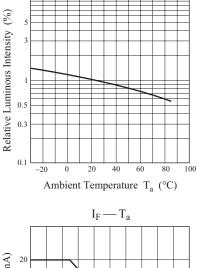
Note) *: Measurement tolerance: ±20%







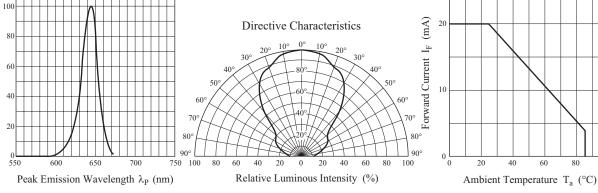


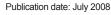


40

60

80



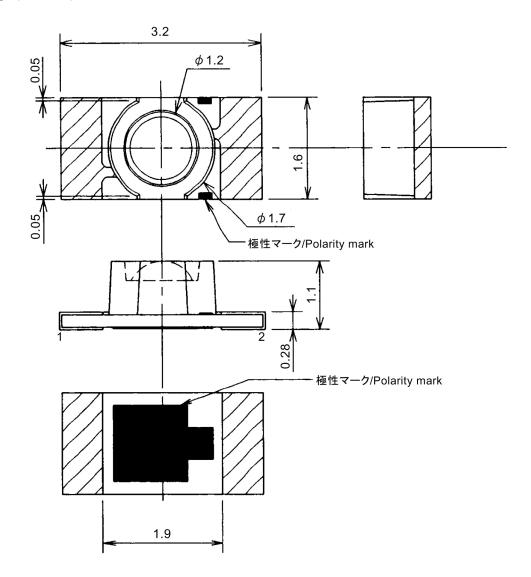


Relative Luminous Intensity (%)

100

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Package (Unit: mm)



- Pin name
 - 1: Anode
 - 2: Cathode

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